Applicant requests reconsideration of the objection to the drawings as well as the

rejection of the claims under 35 U.S.C. § 112, set forth by the Examiner.

Applicant notes that the subject matter of claim 2 is directed to the embodiment of the

invention described with reference to Figures 9A and 9B, wherein the coil member has

portions with an air gap between the coil and the polyimide layer. More specifically, as noted

in the Specification in last paragraph on page 18, the spiral-shaped coil 18 is embedded in the

surface of the polyimide layer 20 as whole, and most of it is structured as an aerial wire

separated from the polyimide layer 20.

As further described in the preceding paragraph, the spiral-shaped coil is supported by

the polyimide layer 20 in an area that is sandwiched between two semispherical recesses 28A

and 28B. The bottom and the side surface of the spiral-shaped coil 18 are coated and held by

the polyimide layer 20 only in the area sandwiched between the two semispherical recesses.

Figures 9A and 9B clearly demonstrate the subject matter described in the reference

portions of the specification as well as the claims which are consistent with that description.

Accordingly, in light of the foregoing applicant requests that the Examiner withdraw

the objections to the drawings and the rejections under §112.

Applicant respectfully requests reconsideration of the prior art rejections set forth by

the Examiner under 35 U.S.C. §§102 and 103. Applicant submits that the prior art references

of record, whether considered alone, or in combination, fail to either teach or suggest

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Applicants presently claimed invention. More specifically, as noted above, Applicants

claimed invention is directed to a coil member formed on an insulating body wherein portions

of the coil are separated by an air gap from the adjacent insulating body and portions are

directly supported by the insulating body. The prior art references of record provide no

teaching or suggestion whatsoever regarding this advance in the art. In particular, Applicant

notes that the Li reference, United States Patent No. 5,477,204 provides no teaching or

suggestion regarding a coil structure formed in the substrate wherein portions of the coil are

covered by the substrate and other portions having a gap between a bottom surface of the coil

and a substrate.

In contrast with the assertions of the Examiner, the actual structure and the only

embodiment described in the Specification of the prior art is directed to a transformer 100

having a flat substrate 101 and having a dielectric constant that is higher than air. See

specifically column 1 at lines 55-60. As noted therein, the high dielectric constant of the

substrate is highly desirable in order to reduce the size of the transformer. Accordingly, this

reference actually teaches away from the subject matter of the instant invention employing an

air gap. There is simply no teaching or suggestion whatsoever regarding portions having an

air gap. It appears that the plating of this structure referenced in the drawing may have

caused confusion, but the plating is actually on an opposite side from the coil runners 124

and 126. There is just no air gap whatsoever.

Accordingly, in light of the foregoing, Applicant requests that the Examiner with the

rejections and allow all claims in the application.

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Respectfully submitted,

Date: 10/13/04

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